

12CLQ150

SCHOTTKY RECTIFIER

35 Amp

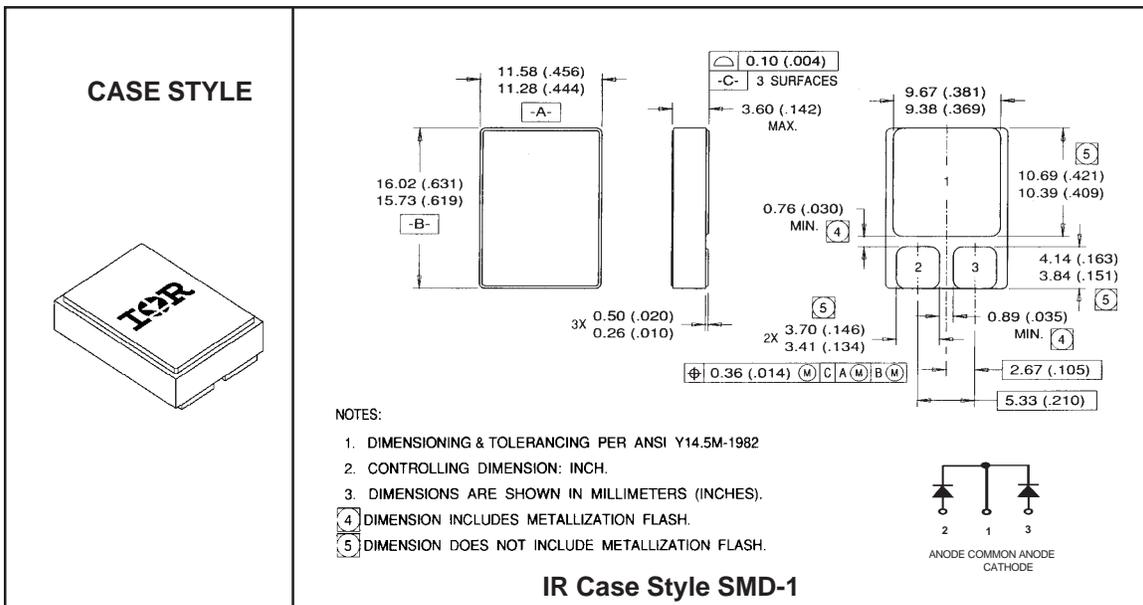
Major Ratings and Characteristics

Characteristics	12CLQ150	Units
$I_{F(AV)}$ Rectangular waveform	35	A
V_{RRM}	150	V
I_{FSM} @ $t_p = 8.3ms$ sine	200	A
V_F @ 15Apk, $T_J = 125^\circ C$ (Per Leg)	0.86	V
T_J, T_{stg} Operating and storage	-55 to 150	$^\circ C$

Description/Features

The 12CLQ150 center tap Schottky rectifier has been expressly designed to meet the rigorous requirements of hi-rel environments. It is packaged in the hermetic surface mount SMD-1 ceramic package and has extremely low reverse leakage at high temperature. Full MIL-PRF-19500 quality conformance testing is available on source control drawings to JANTX, JANTXV, or S levels. Typical applications include switching power supplies and resonant power converters.

- Hermetically sealed
- Low forward voltage drop
- Center tap
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Surface Mount
- Lightweight



Voltage Ratings

Part Number	12CLQ150
V_R Max. DC Reverse Voltage (V) (Per Leg)	150
V_{RWM} Max. Working Peak Reverse Voltage (V) (Per Leg)	

Absolute Maximum Ratings

Parameters	12CLQ150	Units	Conditions
$I_{F(AV)}$ Max. Average Forward Current See Fig. 4	35	A	50% duty cycle @ $T_C = 100^\circ\text{C}$, rectangular waveform
I_{FSM} Max. Peak One Cycle Non - Repetitive Surge Current (Per Leg)	200	A	@ $t_p = 8.3$ ms sine

Electrical Specifications

Parameters	12CLQ150	Units	Conditions	
V_{FM} Max. Forward Voltage Drop (Per Leg) See Fig. 1 ①	1.13	V	@ 15A	$T_J = 25^\circ\text{C}$
	1.6	V	@ 35A	
	0.86	V	@ 15A	$T_J = 125^\circ\text{C}$
	1.20	V	@ 35A	
I_{RM} Max. Reverse Leakage Current (Per Leg) See Fig. 2 ①	0.50	mA	$T_J = 25^\circ\text{C}$	$V_R = \text{rated } V_R$
	15	mA	$T_J = 125^\circ\text{C}$	
C_T Max. Junction Capacitance (Per Leg)	340	pF	$V_R = 5V_{DC}$, (test signal range 100KHz to 1MHz) 25°C	
L_S Typical Series Inductance (Per Leg)	2.8	nH	Measured mounting plane to lead 5mm from package body	

Thermal-Mechanical Specifications

Parameters	12CLQ150	Units	Conditions	
T_J Max. Junction Temperature Range	-55 to 150	$^\circ\text{C}$		
T_{stg} Max. Storage Temperature Range	-55 to 150	$^\circ\text{C}$		
R_{thJC} Max. Thermal Resistance, Junction to Case (Per Leg)	1.67	$^\circ\text{C/W}$	DC operation See Fig. 5	
R_{thJC} Max. Thermal Resistance, Junction to Case (Per Package)	0.83	$^\circ\text{C/W}$	DC operation	
R_{thCS} Typical Thermal Resistance, Case to Heatsink	0.21	$^\circ\text{C/W}$	Mounting surface, smooth and greased	
wt Weight (Typical)	2.6	g		
Die Description (Square)	0.125	inches		
Case Style	SMD-1			

① Pulse Width < 300 μs , Duty Cycle < 2%

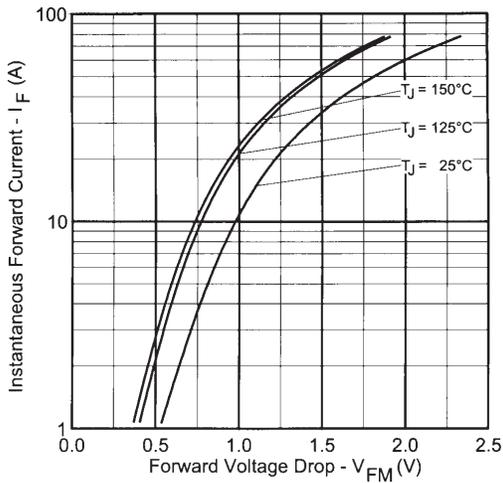


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

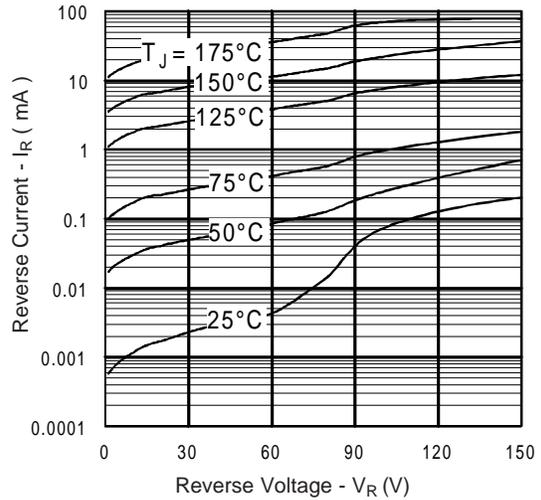


Fig. 2 - Typical Values of Reverse Current Vs. Reverse Voltage (Per Leg)

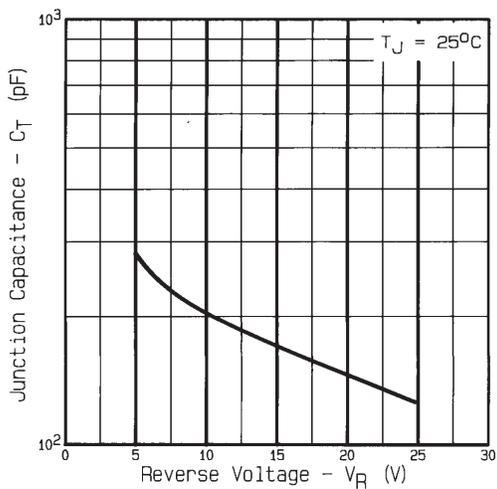


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

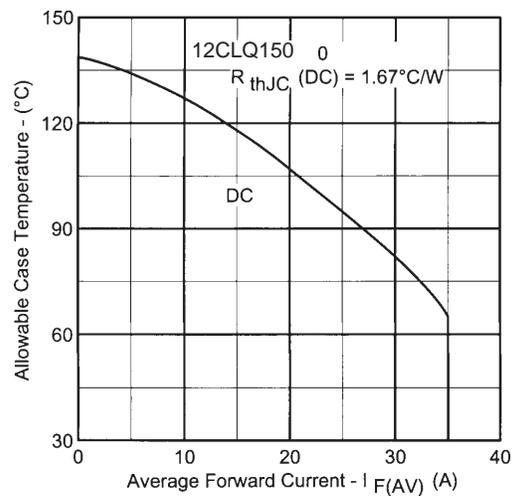


Fig. 4 - Max. Allowable Case Temperature Vs. Average Forward Current (Per Leg)

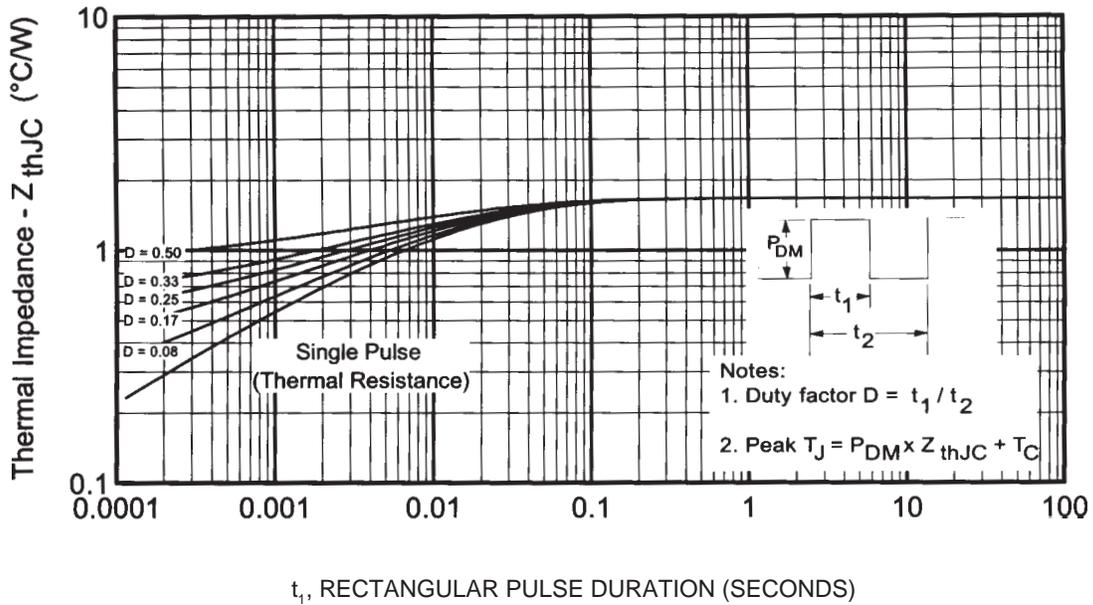


Fig.5 - Max. Thermal Impedance Z_{thJC} characteristics (Per Leg)